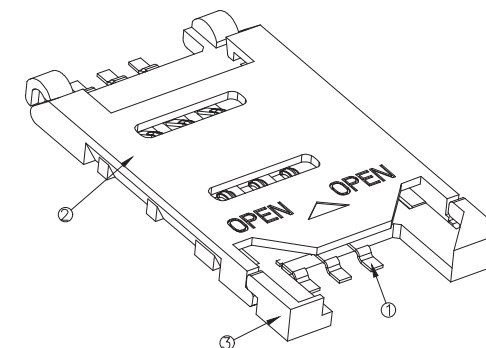
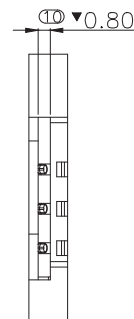
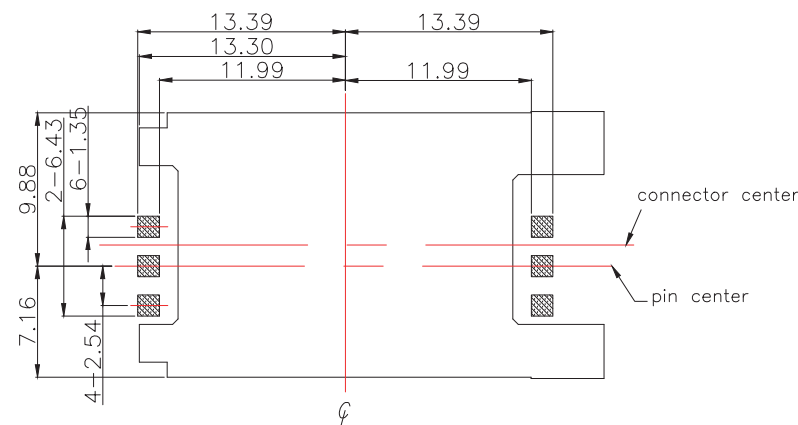
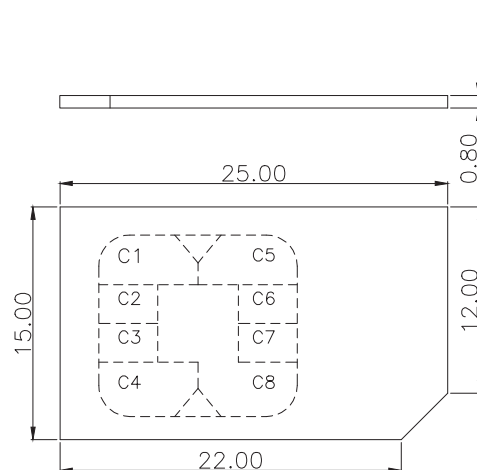




MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A

Manual soldering: 350°C, 3sec. max

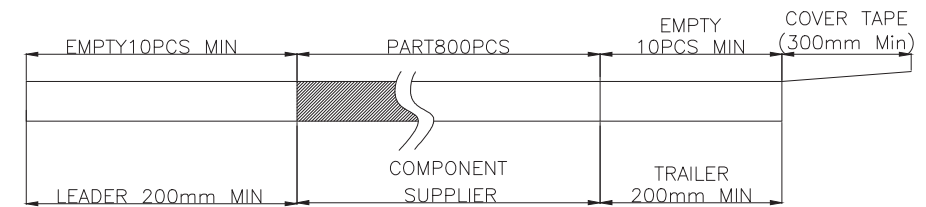


GENERAL TOLERANCE ± 0.05

1	Contact	COPPER ALLOY	Gold FLASH	6	
2	Cover	THERMOPLASTIC,UL 94V=0, COLOR:BLACK			1
3	Housing	THERMOPLASTIC,UL 94V=0, COLOR:BLACK			1
ITEM	NAME	MATERIAl	FINISH	Q'ty	REMARK
MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:SIM CARD CONN 数量式 H2.5mm		
			PAR	SIM-108S-ARP6	
DWN					
CHKD					
APVD					
DECIMALS:	ANGLES:	SCALE:1:1 UNIT:MM 			
X.:±0.50	X*.:±2°	SIZE:A4 SHEET:1F1			
X.X:±0.30	X.X*.:±1°	REV:A			
X.XX:±0.20		CUSTOMER COPY			

NOTES

1. NUMBER OF CONNECTORS:800PCS/REEL
2. LEAD TAPE LENGTH



3. QUANTITY: 8000PCS/CARTON

上下各1PCS珍珠棉

胶纸工字型封箱

CARTON
350*350*340 K=K

LABEL

MANUFACTURE DWG

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS:

X.:±0.50

X.X:±0.30

X.XX:±0.20

ANGLES:

X.:±2°

X.X:±1°

东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co., LtdTITLE:
SIM CARD CONN

PAR SIM-108S-ARP6

DWN

CHKD

APVD

SCALE 1:1 UNIT:MM

SIZE: A4 SHEET: 1F1 REV: A

CUSTOMER COPY